



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Blaine J. Thurgood

Serial No.: 10/685,312

Filed: October 14, 2003

For: INTERPOSER SUBSTRATES WITH MULTISEGMENT INTERCONNECT SLOTS, SEMICONDUCTOR, DIE PACKAGES INCLUDING SAME, SEMICONDUCTOR DICE FOR USE THEREWITH AND METHODS OF FABRICATION

Confirmation No.: 5043

Examiner: Unknown

Group Art Unit: 3726

Attorney Docket No.: 2269-5520.1US

(02-0676.01/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

January 19, 2005

Date

Joseph A. Walkowski

Name (Type/Print)

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO-1449 be considered by the Examiner and made of record. Copies of U.S. patents and U.S. patent publications are not being submitted pursuant to M.P.E.P. 609 III A(2). Copies of foreign patent documents and

non-patent literature are enclosed pursuant to 37 C.F.R. § 1.98(a)(2). The listed documents were cited by the Office in co-pending application Serial No. 10/409,804, filed on April 9, 2003, and directed to a related invention.

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicant herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

U.S. Patent Documents

U.S. Patent No.	Publication Date	<u>Patentee</u>
US - 5,231,878	08/1993	Zanini-Fisher et al.
US - 2002/0008307 A1	01/2002	Dickey
US - 2002/0020689 A1	02/2002	Leung

Applicant offers to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

Serial No. 10/685,312

This Supplemental Information Disclosure Statement is filed before the mailing date of a first Office Action on the merits.

Respectfully submitted,

Joseph A. Walkowski Registration No. 28,765 Attorney for Applicant

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Date: January 19, 2005

JAW/dlm:ljb

Enclosures: Form PTO-1449 or PTO/SB/08

Document in ProLaw

PTO/SB/08A (10-01)

Approved for use through 10/31/2002, OMB 0651-0031

U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

k Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number. Substitute for form 1449A/PTO Complete if Known 10/685,312 Application Number INFORMATION DISCLOSURE October 14, 2003 Filing Date STATEMENT BY APPLICANT Blaine J. Thurgood First Named Inventor Group Art Unit 3726 (use as many sheets as necessary) Examiner Name Unknown 2269-5520.1US (02-0676.01/US) Attorney Docket Number Sheet

		Document Number	Publication Date	Name of Patentee or Applicant of	Pages, Columns, Lines, Where Relevant	
Examiner Cite Initials * No.		Publication	MM-DD-YYYY	Cited Document	Passages or Relevant Figures Appear	
		US-5,231,878	08/1993	Zanini-Fisher et al.		
		US- 2002/0008307 A1	01/2002	Dickey		
		US- 2002/0020689 A1	02/2002	Leung		
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	Country Code ³ - Number ⁴ - Kind Code ³ (if known)	Publication Date MM-DD-YYYY	Applicant of Cited Document	Where Relevant Passages or Relevant Figures Appear	T ⁶	
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Examiner Signature	·	Date Considered	

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^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹ Applicant's unique citation designation number (optional). ² See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.

& TRADEMARK OFFICE MAILROOM DA STAMPED HEREON IS AN ACKNOWLEDGEMENT THATPON THIS DATE THE PATENT & TRADEMARK OFFICE RECEIVED:

Supplemental Information Disclosure Statement (3 pages); and Form RECEIVED PTO/SB/08 (1 page).

Invention:

INTERPOSER SUBSTRATES WITH

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MULTISEGMENT INTERCONNECT SLOTS,
SEMICONDUCTOR, DIE PACKAGES INCLUDIRESK BRITT, P.C.

SAME, SEMICONDUCTOR DICE FOR USE

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Applicant(s):

Blaine J. Thurgood

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